National Semiconductor

LM833
Dual Audio Operational Amplifier

General Description

The LM833 is a dual general purpose operational amplifier designed with particular emphasis on performance in audio systems.

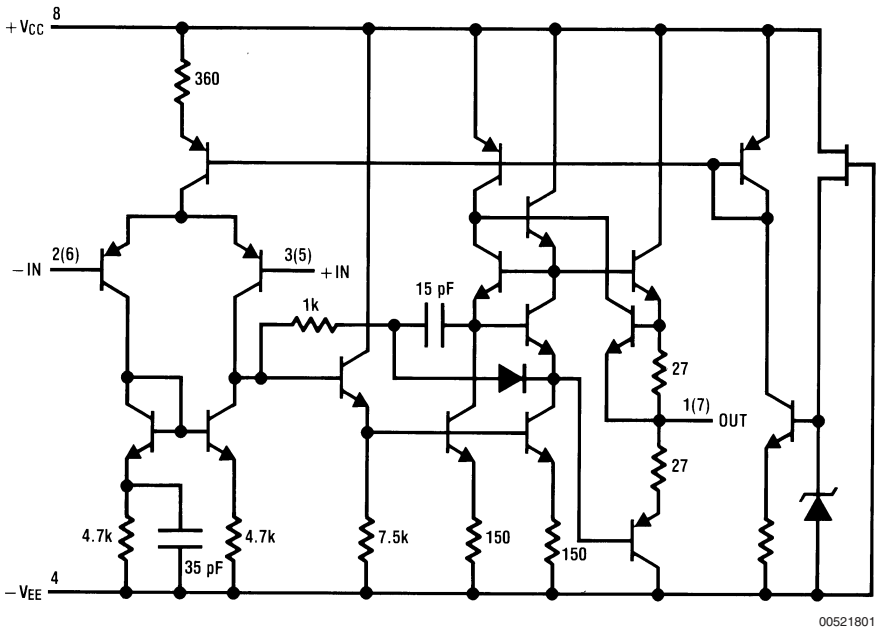
This dual amplifier IC utilizes new circuit and processing techniques to deliver low noise, high speed and wide bandwidth without increasing external components or decreasing stability. The LM833 is internally compensated for all closed loop gains and is therefore optimized for all preamp and high level stages in PCM and HiFi systems.

The LM833 is pin-for-pin compatible with industry standard dual operational amplifiers.

Features

- Wide dynamic range: >140dB
- Low input noise voltage: 4.5nV/√Hz
- High slew rate: 7 V/µs (typ); 5V/µs (min)
- High gain bandwidth: 15MHz (typ); 10MHz (min)
- Wide power bandwidth: 120KHz
- Low distortion: 0.002%
- Low offset voltage: 0.3mV
- Large phase margin: 60˚
- Available in 8 pin MSOP package

Schematic Diagram (1/2 LM833)



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Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage $V_{CC}-V_{EE}$	36V
Differential Input Voltage (Note 3) V_I	±30V
Input Voltage Range (Note 3) V_{IC}	±15V
Power Dissipation (Note 4) P_D	500 mW
Operating Temperature Range T_{OPR}	−40 ~ 85˚C
Storage Temperature Range T_{STG}	−60 ~ 150˚C
Soldering Information	
Dual-In-Line Package	
Soldering (10 seconds)	260˚C
Small Outline Package (SOIC and MSOP)	
Vapor Phase (60 seconds)	215˚C
Infrared (15 seconds)	220˚C
ESD tolerance (Note 5)	1600V

DC Electrical Characteristics (Notes 1, 2)

(T_A = 25˚C, V_S = ±15V)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
V_{OS}	Input Offset Voltage	R_S = 10Ω		0.3	5	mV
I_{OS}	Input Offset Current			10	200	nA
I_B	Input Bias Current			500	1000	nA
A_V	Voltage Gain	R_L = 2 kΩ, V_O = ±10V	90	110		dB
V_{OM}	Output Voltage Swing	R_L = 10 kΩ	±12	±13.5		V
		R_L = 2 kΩ	±10	±13.4		V
V_{CM}	Input Common-Mode Range		±12	±14.0		V
CMRR	Common-Mode Rejection Ratio	V_{IN} = ±12V	80	100		dB
PSRR	Power Supply Rejection Ratio	V_S = 15~5V, −15~−5V	80	100		dB
I_Q	Supply Current	V_O = 0V, Both Amps		5	8	mA

AC Electrical Characteristics

(T_A = 25˚C, V_S = ±15V, R_L = 2 kΩ)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
SR	Slew Rate	R_L = 2 kΩ	5	7		V/μs
GBW	Gain Bandwidth Product	f = 100 kHz	10	15		MHz

Design Electrical Characteristics

(T_A = 25˚C, V_S = ±15V) The following parameters are not tested or guaranteed.

Symbol	Parameter	Conditions	Typ	Units
$\Delta V_{OS}/\Delta T$	Average Temperature Coefficient of Input Offset Voltage		2	μV/˚C
THD	Distortion	R_L = 2 kΩ, f = 20~20 kHz V_{OUT} = 3 Vrms, A_V = 1	0.002	%
e_n	Input Referred Noise Voltage	R_S = 100Ω, f = 1 kHz	4.5	$nV/\sqrt{Hz}$
i_n	Input Referred Noise Current	f = 1 kHz	0.7	$pA/\sqrt{Hz}$
PBW	Power Bandwidth	V_O = 27 V_{pp}, R_L = 2 kΩ, THD ≤ 1%	120	kHz
f_U	Unity Gain Frequency	Open Loop	9	MHz
ϕ_M	Phase Margin	Open Loop	60	deg
	Input Referred Cross Talk	f = 20~20 kHz	−120	dB

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Design Electrical Characteristics (Continued)

Note 1: *Absolute Maximum Ratings* indicate limits beyond which damage to the device may occur. *Operating Ratings* indicate conditions for which the device is functional, but do not guarantee specific performance limits. *Electrical Characteristics* state DC and AC electrical specifications under particular test conditions which guarantee specific performance limits. This assumes that the device is within the Operating Ratings. Specifications are not guaranteed for parameters where no limit is given, however, the typical value is a good indication of device performance.

Note 2: All voltages are measured with respect to the ground pin, unless otherwise specified.

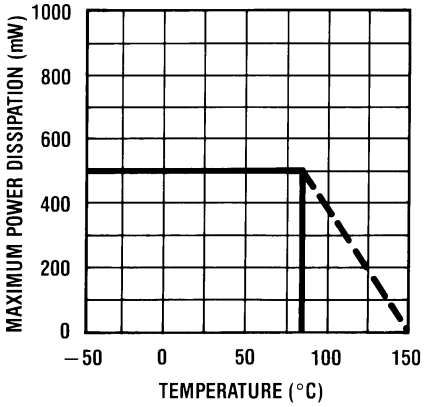
Note 3: If supply voltage is less than ±15V, it is equal to supply voltage.

Note 4: This is the permissible value at $T_A \leq 85^\circ C$.

Note 5: Human body model, 1.5 kΩ in series with 100 pF.

Typical Performance Characteristics

Maximum Power Dissipation vs Ambient Temperature



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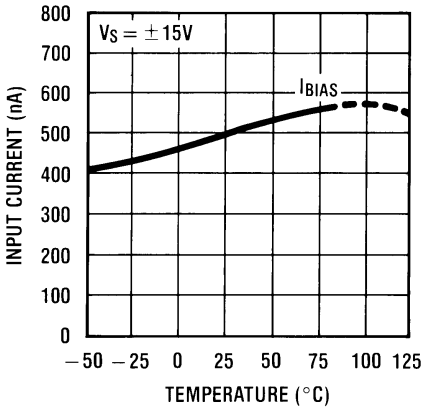
Input Bias Current vs Ambient Temperature



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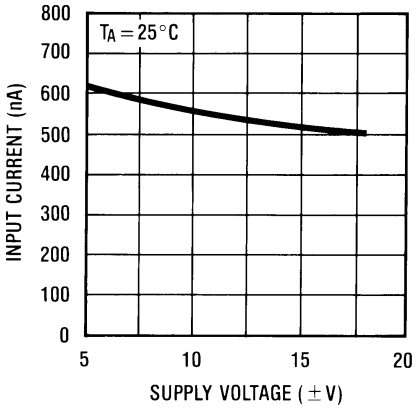
Input Bias Current vs Supply Voltage



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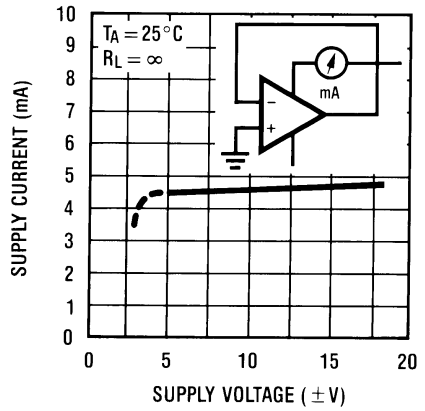
Supply Current vs Supply Voltage



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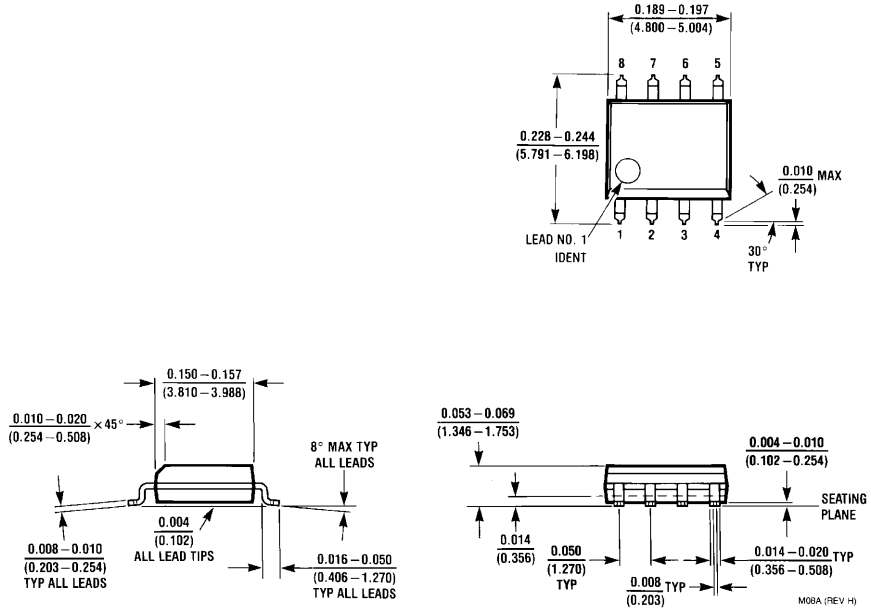
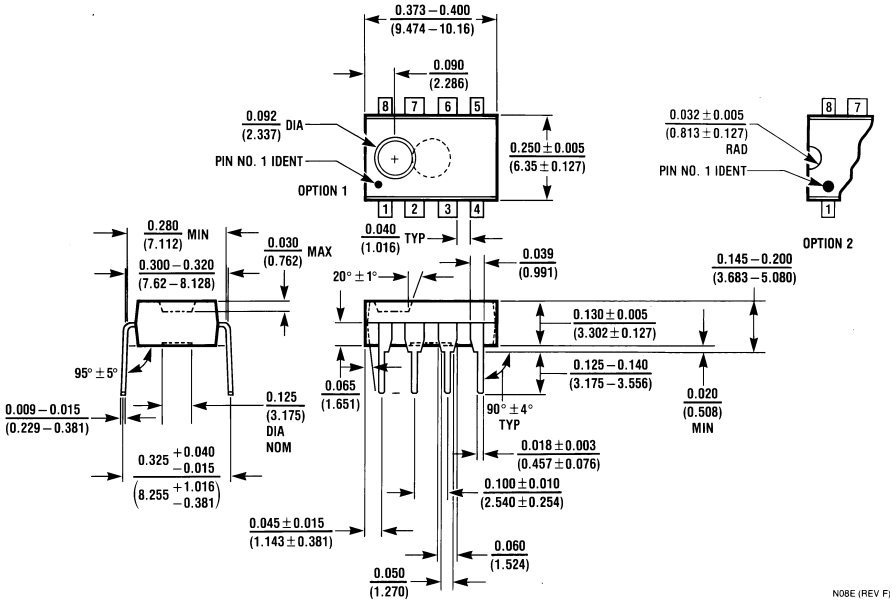
Physical Dimensions inches (millimeters) unless otherwise noted



Molded Small Outline Package (M)
Order Number LM833M or LM833MX
NS Package Number M08A



Molded Dual-In-Line Package (N)
Order Number LM833N
NS Package Number N08E

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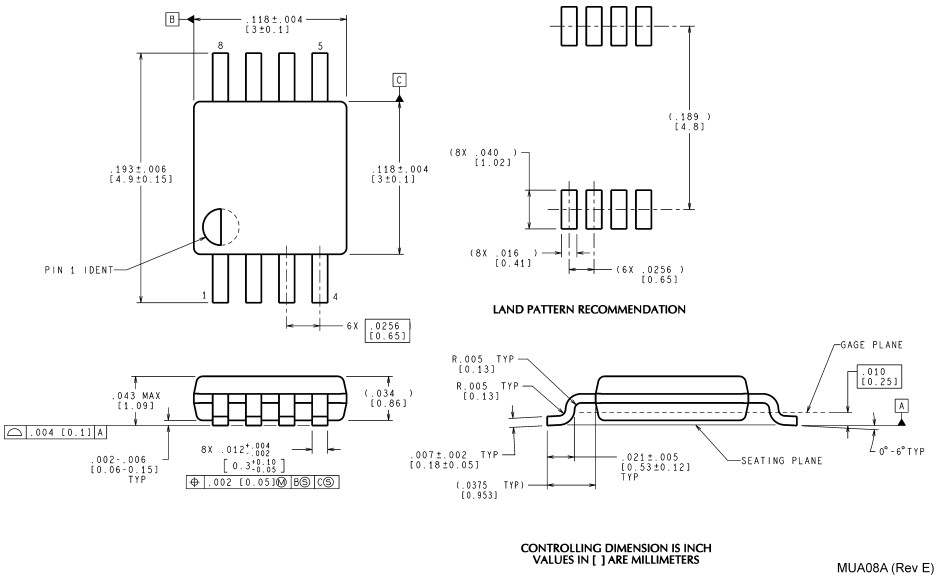
Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



8-Lead (0.118" Wide) Molded Mini Small Outline Package
Order Number LM833MM or LM833MMX
NS Package Number MUA08A

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